

DATA SHEET



# N-Channel Silicon MOSFET **CPH3445**—General-Purpose Switching Device **Applications**

**Features** 

• 4V drive.

## **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		30	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	١D		3.5	Α
Drain Current (Pulse)	IDP	PW≤10µs, duty cycle≤1%	14	A
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm <sup>2</sup> X0.8mm)	1	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			1.114
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	30			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	VGS=±16V, VDS=0V			±10	μΑ
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =1.8A	1.5	2.6		S
Static Drain-to-Source On-State Resistance	RDS(on)1	ID=1.8A, VGS=10V		52	68	mΩ
	R <sub>DS</sub> (on)2	ID=0.9A, VGS=4.5V		88	125	mΩ
	R <sub>DS</sub> (on)3	ID=0.9A, VGS=4V		98	140	mΩ
Input Capacitance	Ciss	VDS=10V, f=1MHz		295		pF
Output Capacitance	Coss	V <sub>DS</sub> =10V, f=1MHz		65		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =10V, f=1MHz		50		pF
Turn-ON Delay Time	td(on)	See specified Test Circuit.		8.0		ns
Rise Time	tr	See specified Test Circuit.		29		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		27		ns
Fall Time	tf	See specified Test Circuit.		29.5		ns

Marking : ZU

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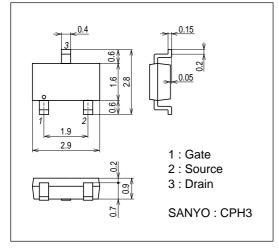
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Parameter	Symbol	Conditions		Ratings		
	Gymbol		min	typ	max	Unit
Total Gate Charge	Qg	VDS=10V, VGS=10V, ID=3.5A		7.2		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		1.1		nC
Gate-to-Drain "Miller" Charge	Qgd	VDS=10V, VGS=10V, ID=3.5A		1.3		nC
Diode Forward Voltage	VSD	IS=3.5A, VGS=0V		0.87	1.2	V

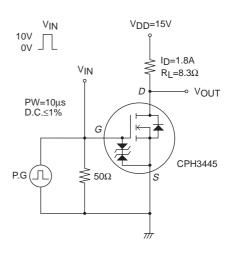
#### **Package Dimensions**

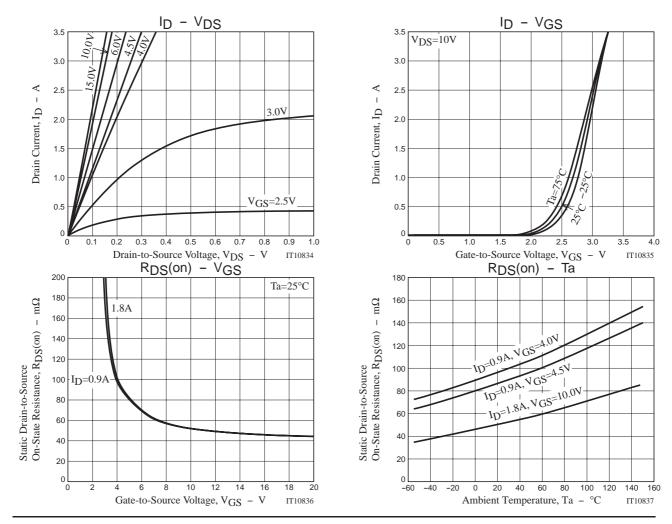
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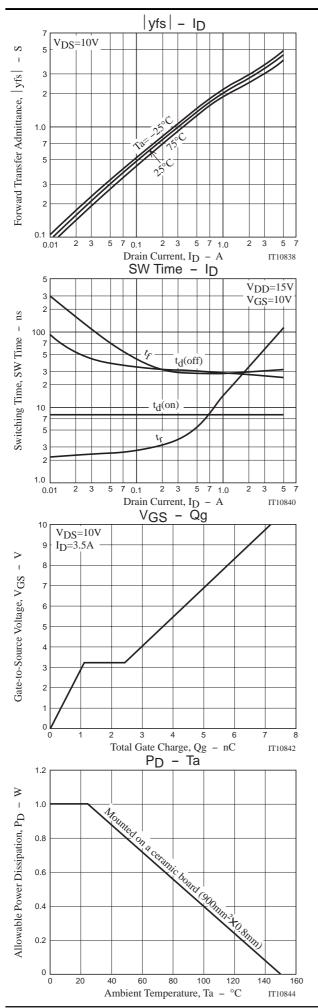
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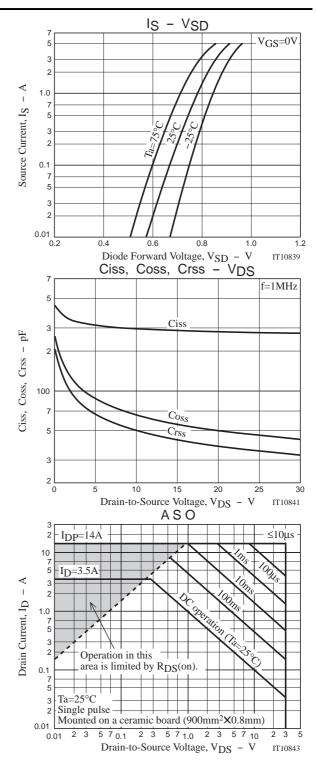


### **Switching Time Test Circuit**









Note on usage : Since the CPH3445 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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